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SEMICONDUCTOR®

May 2010

FDMA507PZ

Single P-Channel PowerTrench[®] MOSFET

-20 V, -7.8 A, 24 mΩ

Features

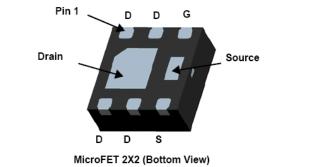
- Max $r_{DS(on)}$ = 24 m Ω at V_{GS} = -5 V, I_D = -7.8 A
- Max $r_{DS(on)} = 25 \text{ m}\Omega$ at $V_{GS} = -4.5 \text{ V}$, $I_D = -7 \text{ A}$
- Max $r_{DS(on)}$ = 35 m Ω at V_{GS} = -2.5 V, I_D = -5.5 A
- Max $r_{DS(on)}$ = 45 m Ω at V_{GS} = -1.8 V, I_D = -4 A
- Low Profile 0.8 mm maximum in the package MicroFET 2X2 mm
- HBM ESD protection level > 3.2K V typical (Note3)
- Free from halogenated compounds and antimony oxides
- RoHS Compliant

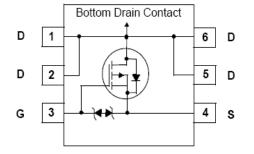


General Description

This device is designed specifically for battery charge or load switching in cellular handset and other ultraportable applications. It features a MOSFET with low on-stade resistance.

The MicroFET 2X2 package offers exceptional thermal perfomance for its physical size and is well suited to linear mode applications.





MOSFET Maximum Ratings T_A = 25 °C unless otherwise noted

Symbol	Par	Ratings	Units		
V _{DS}	Drain to Source Voltage	-20	V		
V _{GS}	Gate to Source Voltage			±8	V
I _D	Drain Current -Continuous	T _A = 25 °C	(Note 1a)	-7.8	•
	-Pulsed			-24	Α
D	Power Dissipation	T _A = 25 °C	(Note 1a)	2.4	14/
P _D	Power Dissipation	T _A = 25 °C	(Note 1b)	0.9	W
T _J , T _{STG}	Operating and Storage Junction Tem	perature Range		-55 to +150	°C

Thermal Characteristics

R_{\thetaJA}	Thermal Resistance, Junction to Ambient	(Note 1a)	52	°C/W
R_{\thetaJA}	Thermal Resistance, Junction to Ambient	(Note 1b)	145	C/VV

Package Marking and Ordering Information

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
507	FDMA507PZ	MicroFET 2X2	7 "	12 mm	3000 units

Symbol	Parameter	Test Conditions	Min	Тур	Max	Units
Off Chara	cteristics					
BV _{DSS}	Drain to Source Breakdown Voltage	$I_{D} = -250 \ \mu A, \ V_{GS} = 0 \ V$	-20			V
ΔBV _{DSS} ΔT _J	Breakdown Voltage Temperature Coefficient	I_D = -250 µA, referenced to 25 °C		-12		mV/°C
IDSS	Zero Gate Voltage Drain Current	V _{DS} = -16 V, V _{GS} = 0 V			-1	μA
I _{GSS}	Gate to Source Leakage Current	$V_{GS} = \pm 8 \text{ V}, V_{DS} = 0 \text{ V}$			±10	μA
On Chara	cteristics					
V _{GS(th)}	Gate to Source Threshold Voltage	$V_{GS} = V_{DS}, I_{D} = -250 \ \mu A$	-0.4	-0.5	-1.5	V
$\frac{\Delta V_{GS(th)}}{\Delta T_J}$	Gate to Source Threshold Voltage Temperature Coefficient	$I_D = -250 \ \mu\text{A}$, referenced to 25 °C		3		mV/°C
r _{DS(on)}	Drain to Source On Resistance	$V_{GS} = -5 \text{ V}, \text{ I}_{D} = -7.8 \text{ A}$		19	24	mΩ
		$V_{GS} = -4.5 \text{ V}, I_D = -7 \text{ A}$		20	25	
		$V_{GS} = -2.5 \text{ V}, \text{ I}_{D} = -5.5 \text{ A}$		24	35	
		$V_{GS} = -1.8 \text{ V}, \text{ I}_{D} = -4 \text{ A}$		29	45	
		V_{GS} = -5 V, I_{D} = -7.8 A, T_{J} = 125 °C		26	34	
9 _{FS}	Forward Transconductance	$V_{DS} = -5 V$, $I_{D} = -7.8 A$		33		S
Dynamic	Characteristics					
C _{iss}	Input Capacitance			1515	2015	pF
C _{oss}	Output Capacitance	─ V _{DS} = -10 V, V _{GS} = 0 V, f = 1 MHz		265	355	pF
C _{rss}	Reverse Transfer Capacitance			240	360	pF
Switching	Characteristics					
t _{d(on)}	Turn-On Delay Time			6.4	13	ns
t _r	Rise Time	$V_{DD} = -10 \text{ V}, \text{ I}_{D} = -7.8 \text{ A}$		14	25	ns
t _{d(off)}	Turn-Off Delay Time	$V_{GS} = -5 V, R_{GEN} = 6 \Omega$		192	307	ns
t _f	Fall Time	7		96	154	ns
Q _{g(TOT)}	Total Gate Charge			30	42	nC
Q _{gs}	Gate to Source Gate Charge	$-V_{DD} = -10 V$, $I_D = -7.8 A$ $-V_{GS} = -5 V$		2		nC
Q _{gd}	Gate to Drain "Miller" Charge	GS3 v		7.5		nC
Drain-Sou	rce Diode Characteristics					
V _{SD}	Source to Drain Diode Forward Voltage	$V_{GS} = 0 V, I_S = -2.0 A$ (Note 2)		-0.6	-1.2	V

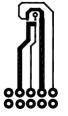
V _{SD}	Source to Drain Diode Forward Voltage	V _{GS} = 0 V, I _S = -2.0 A (Note 2)	-0.6	-1.2	V
t _{rr}	Reverse Recovery Time	-I _F = -7.8 A, di/dt = 100 A/μs	66	106	ns
Q _{rr}	Reverse Recovery Charge	$F_{\rm F} = -7.8 \text{A}, \text{u/at} = 100 \text{A/} \mu \text{s}$	44	70	nC

Notes:

1. $R_{\theta JA}$ is determined with the device mounted on a 1 in² pad 2 oz copper pad on a 1.5 x 1.5 in. board of FR-4 material. $R_{\theta JC}$ is guaranteed by design while $R_{\theta CA}$ is determined by the user's board design.



a. 52 °C/W when mounted on a 1 in² pad of 2 oz copper.



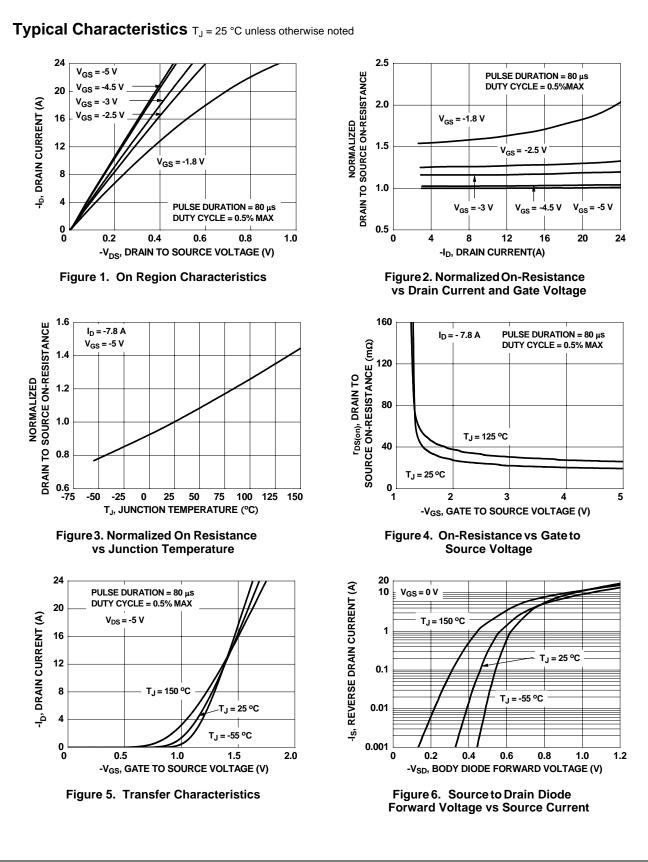
b. 145 °C/W when mounted on a minimum pad of 2 oz copper.

2. Pulse Test: Pulse Width < 300 $\mu s,$ Duty cycle < 2.0%.

3. The diode connected between the gate and source serves only as protection against ESD. No gate overvoltage rating is implied.

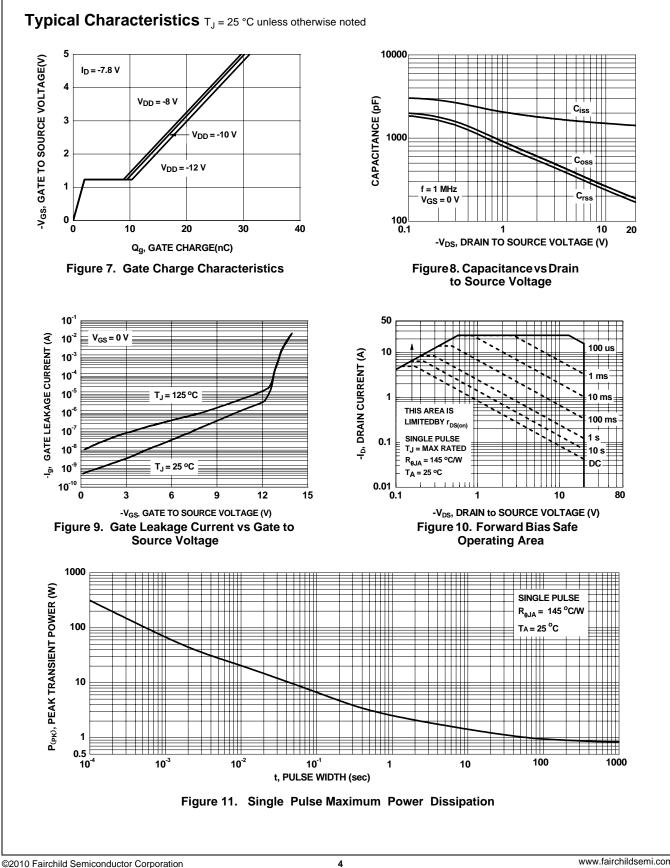
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FDMA507PZ Single P-Channel PowerTrench[®] MOSFET



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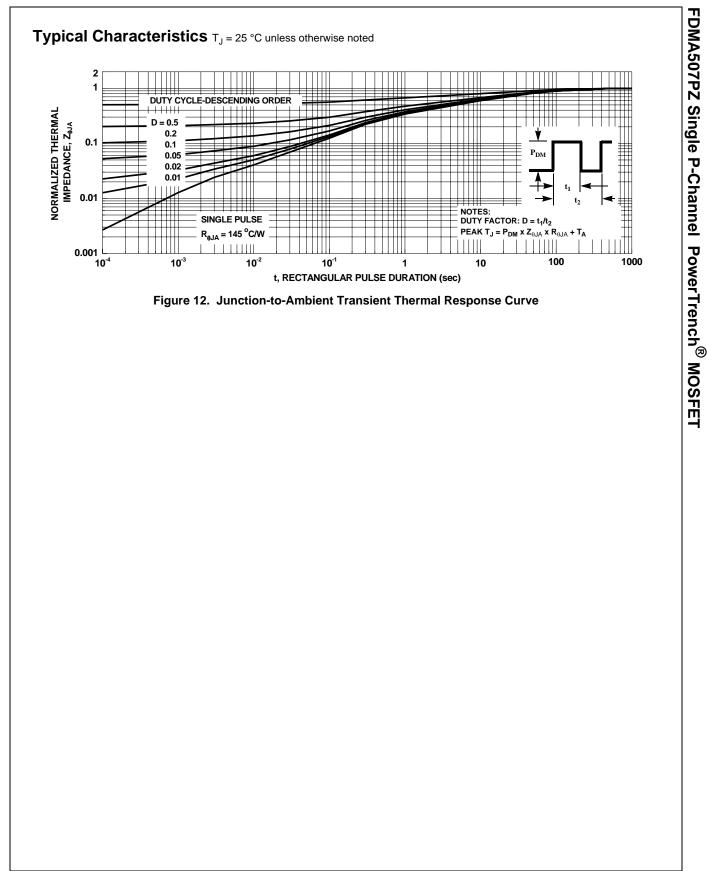


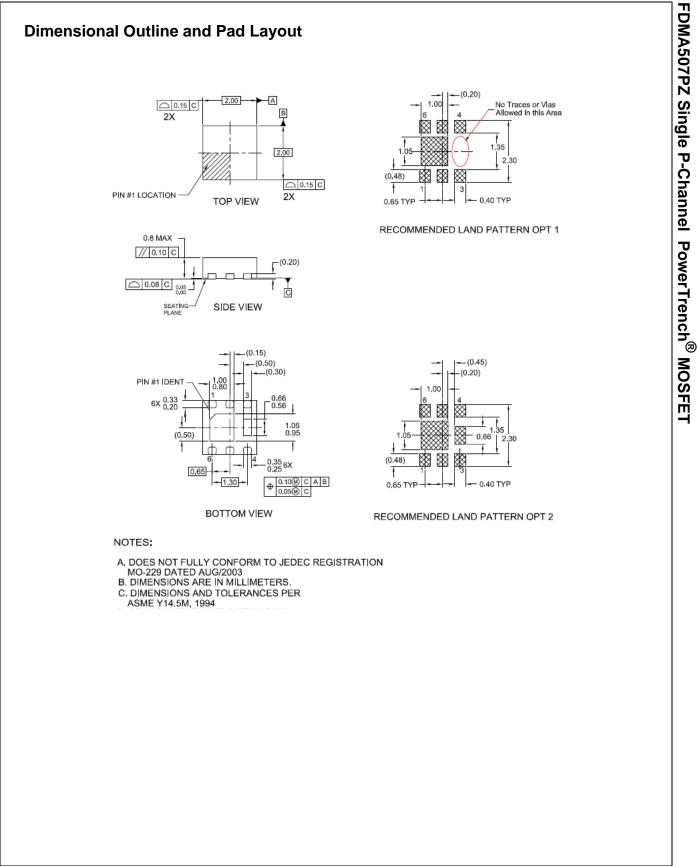
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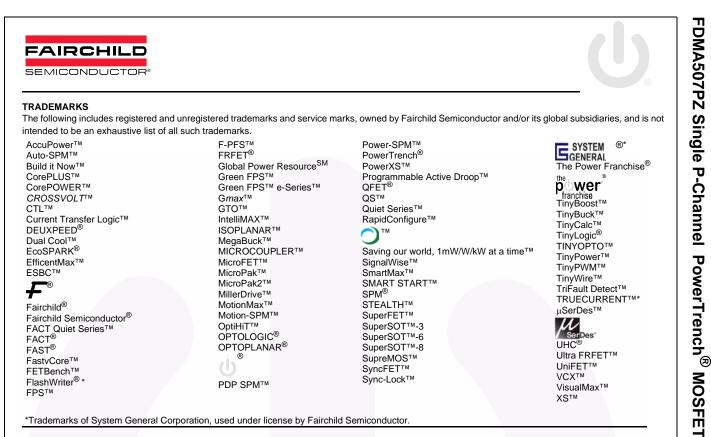
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